

- HV switch in Trench-FET technology for extremely low on-resistance
- Very EMC tolerant
- Low control power also at higher switching frequencies
- Available with on-time options from 100ns to 100µs

Note: The model number contains coded information about voltage, current and turn-on behavior. The first digits stand for the voltage in kV, the last digit before the dash indicates the turn-on behavior (0 = fixed on-time, 1 = variable on-time). The digits after the dash indicate the current in Amperes x10. Special features are coded by the letters after a second dash.
Example HTS 40-06-B: HTS = HV Transistor Switch, 4 = 4 kV, 0 = fixed on-time, 06 = 60 Ampere, B = Trench-FET

Model [sorted by dimensions]	Description / Comment ● Preferred stock type ○ Limited stock X Not for new development	Drawing (PDF)	Dimensions [mm ³]	Voltage [kV]	Pk. Current [A]	On-Resist. [Ω]	On-Time [ns]
HTS 40-06-B	● Tubular housing with pigtail connectors. Cooling options not available.	request	135 x 20 x 20	4.8	60	1.52	150
HTS 40-12-B	● LED indicators. Very compact design - CF options partly not applicable!	request	79 x 38 x 25	4.8	120	0.76	150
HTS 90-06-B	● LED indicators. Very compact design - CF options partly not applicable!	request	79 x 38 x 25	9.6	60	3.04	150
HTS 40-26-B	● LED indicators. Very compact design - CF options partly not applicable!	request	79 x 38 x 25	4.8	260	1.3	220
HTS 90-13-B	● LED indicators. Very compact design - CF options partly not applicable!	request	79 x 38 x 25	9.6	130	0.65	220
HTS 100-12-B	●	request	89 x 64 x 27	10.8	120	1.71	200
HTS 30-60-B	●	request	89 x 64 x 31	3	600	0.19	150
HTS 60-24-B	●	PDF	89 x 64 x 31	6	240	0.48	150
HTS 60-30-B	●	request	89 x 64 x 31	6	300	0.38	150
HTS 70-30-B	● Compact design - CF options partly not applicable!	request	89 x 64 x 31	7.2	300	0.46	150
HTS 40-60-B	●	request	122 x 64 x 31	4.8	600	0.3	150
HTS 90-30-B	●	request	122 x 64 x 31	9.6	300	0.6	150
HTS 60-60-B	●	request	153 x 64 x 31	6	600	0.38	150
HTS 120-30-B	●	request	153 x 64 x 31	12	300	0.76	150
HTS 160-48-B	● LED indicators & Sync. I/O. CF options partly not applicable!	request	174 x 103 x 35	16.8	480	0.67	150
HTS 90-96-B	● LED indicators & Sync. I/O for parallel connection.	request	204 x 103 x 35	9	960	0.71	150
HTS 180-48-B	● LED indicators & Sync. I/O for parallel connection.	request	204 x 103 x 35	18	480	0.71	150
HTS 120-96-B	● LED indicators & Sync. I/O for parallel connection.	request	253 x 103 x 35	12	960	0.48	150
HTS 240-48-B	● LED indicators & Sync. I/O for parallel connection.	request	253 x 103 x 35	24	480	0.95	150
HTS 240-104-B	● LED indicators & Sync. I/O for parallel connection	request	253 x 103 x 35	24	1040	0.4	250

Options (1)

B-CON	Beginner's Configuration: The standard switch is equipped with various options to simplify first time experiments for users which are inexperienced with high voltage and high frequency circuit design. The beginner's configuration includes option FH and PT-HV for easy wiring and attachment without printed circuit boards, as well as option LS-C, LP and S-TT for an uncritical EMC behavior. Inexperienced users should also consider the combination with option I-PC or PC to avoid possible difficulties from the high voltage wiring and / or high frequency noise behavior. (2)
HFB	High Frequency Burst: Improved burst capability of driver by means of external buffer capacitors. Recommended if more than 10 pulses with less than 10 µs spacing are generated.
HFS	High Frequency Switching: External supply of auxiliary driver voltage (50-350 VDC according to type). Necessary if the specified "Maximum Operating Frequency" shall be exceeded. (2)
LP	Low Pass: Low pass filter at the control input. Propagation delay time will be increased by ~50 ns. Jitter + 500 ps. Improved noise immunity and less critical wiring in high speed applications. (3)
DT	Delayed Trigger: "Total Turn-On Time" irreversibly increased to >1 µs. Required if national or international export restrictions apply ("dual use products"). (2)
S-ON	Soft Turn-On: Turn-On Rise Time increased by ~20%. Simplified EMC design and less critical wiring if the shortest possible edge steepness is not required. (3)
S-OFF	Soft Turn-Off: Turn-Off Rise Time increased by ~20%. Simplified EMC design and less critical wiring if the shortest possible edge steepness is not required. (3)
S-TT	Soft Transition Time: Turn-On Rise Time & Turn-Off Rise Time increased by ~20%. Simplified EMC design and less critical wiring if the shortest possible edge steepness is not required. (3)
TT-C	Customized Transition Time: Customized rise & fall times to meet individual design requirements. (2)
TT-P	Programmable Transition Time: Switching speed adjustable in certain limits by means of external programming resistors. (2)
OT-1µ	On-Time Extension: On-Time increased to 1 µs. Turn-Off Rise Time >500 ns.
OT-10µ	On-Time Extension: On-Time increased to 10 µs. Turn-Off Rise Time > 5 µs.
OT-100µ	On-Time Extension: On-Time increased to 100 µs. Turn-Off Rise Time >50 µs.
OT-C	Customized On-Time: On-Time according to customer's specifications. Any value between 100 ns and 100 µs.
OT-P	Programmable On-Time: On-Time adjustable in certain limits by means of external programming resistors. (2)
MIN-PS	Minimum Pulse Spacing: Individually increased Recovery Time to ensure a minimum HV pulse spacing independently of control pulse spacing. For safety relevant circuits.
ST	Stage Tapping: Connectors at the individual stages of stack in order to utilize single power semiconductors. To achieve fast rise times also at very low operating voltages (<0.01xVo).
LNC	Low Natural Capacitance: C _n reduced by approximately 30%. To minimize capacitive power losses in applications with high switching frequency and high switching voltage (P _c = V ² x C x f).
LL	Low Leakage Current: Off-state current reduced to less than 10% of the specified value. Not available in connection with the cooling fin options and for switches of the UF series.
ISO-25	25 kV Isolation: Isolation Voltage increased to 25 kVDC. Housing dimensions may change for some models.
ISO-40	40 kV Isolation: Isolation Voltage increased to 40 kVDC. Housing dimensions may change for some models. Only in connection with option PT-HV.
ISO-80	80 kV Isolation: Isolation Voltage increased to 80 kVDC. Housing dimensions may change for some models. Only in connection with option PT-HV.
I-PC	Integrated Part Components: Integration of small part components according to customer's specifications (e.g. buffer capacitors, snubbers, damping resistors, diodes, opto couplers). (2)
I-FWD	Integrated Free-Wheeling Diode: Built-in parallel diode with short recovery time. In connection with inductive load only.
I-FWDN	Integrated Free-Wheeling Diode Network: Built-in parallel diode plus serial blocking diode with short recovery time. In connection with inductive load only.
SEP-C	Separate Control Unit: Control unit with LED indicators in a separate housing (dim. 79x38x17 mm). Linkage cable (<1m) with plug. Control unit with soldering pins or pigtails
FOI-C	Fibre Optics Input / Control: Additional optical control input to trigger the switch with a fibre-optical signal (only in combination with option SEP-C) (2)

FOO-F	Fibre Optics Output / Fault: Additional optical output to read-out the failure condition with a fibre-optical signal (only in combination with option SEP-C) (2)
I-PC	Integrated Part Components: Integration of small part components according to customer's specifications (e.g. buffer capacitors, snubbers, damping resistors, diodes, opto couplers). (2)
LS-C	LEMO socket for Control Connection. Input Z=100Ω. An assembled linkage cable (1m/3ft) with two plugs and one socket is included in supply. Improved noise immunity. (3)
PT-C	Pigtails for Control Connection: Flexible leads (l=75 mm) with PCB connector. This option is only relevant for switching modules with pins. Recommended for modules with options CF & GCF.
PIN-C	Pins for Control Connection: Gold plated pins for printed circuit board designs (special sockets available). This option is only relevant for switching modules which have pigtails as standard.
PT-HV	Pigtails for HV Connection: Flexible leads with cable lugs. For increased creepage. PT-HV is standard for all types with >25 kV switching voltage. Not recommended in extremely fast circuits.
ST-HV	Screw Terminals for HV Connection: Threaded inserts at the bottom of module (if not standard). For PCB design. Operation above 25 kV requires liquid insulation (Galden®/Oil) or potting.
UL94	Flame Retardant Casting Resin: Casting resin according to UL-94-VO. Minimum order quantity required. (2)
FH	Flange Housing: Plastic flange housing for isolated attachment on conductive surfaces. Ideal if the switch is not intended for printed circuit boards. Option PT-HV is suggested.
TH	Tubular Housing: Tubular instead of rectangular housing. Adaption to specific ambient conditions or in case of difficult assembly situations. .
FC	Flat Case: Height of standard plastic housings reduced to 19 mm or less. Not in combination with cooling options CF, GCF and DLC.
ITC	Increased Thermal Conductivity: Special moulding process to increase the thermal conductivity of the module. Pd(max) will be increased by approx. 20-30%. (2)
CF	Copper Cooling Fins d = 0.5 mm: Fin height 35 mm. Nickel plated. For air cooling with forced or natural convection as well as for liquid cooling with non-conductive coolants.
CF-1	Copper Cooling Fins d = 1 mm: Fin thickness 1.0 mm instead of 0.5 mm. The Max. Power Dissipation Pd(max) will be increased by ~80 %. For air or liquid cooling (e.g. Galden® or oil).
CF-X2	Copper Cooling Fins "XL": Fin area enlarged by factor 2. Recommended for natural air convection. No significant cooling power improvement in connection with forced air or liquid cooling.
CF-X3	Copper Cooling Fins "XXL": Fin area enlarged by factor 3. Recommended for natural air convection. No significant cooling power improvement in connection with forced air or liquid cooling.
CF-CS	Copper Cooling Fins with customized shape: Individual shape to meet specific OEM requirements. (2) Can be combined with options CF-1, CF-D and CF-S for increased cooling power.
CF-LC	Copper Cooling Fins for liquid cooling: Double fins, nickel plated copper, height 20 mm. For the immersion in oil tanks etc. Forced convection recommended. Combinable with opt. CF-S.
CF-D	Double Copper Cooling Fins: Approx. 100% more cooling power, approx. 2mm spacing between fins, forced convection recommended. Combinable with opt. CF-S, CF-X2, CF-X3 and CF-CS.
CF-S	Copper Cooling Fins: Semiconductors soldered on fins. Approx. 30% to 100% more cooling power (type depending). Combinable with options CF-D, CF-X2, CF-X3 and CF-CS.
CF-GRA	Non-isolated Cooling Fins made of graphite: Very light weight compared to copper at similar heat transfer, but reduced heat capacity. 0.5 or 1 mm thickness, height 35 mm.
CF-CER	Isolated Cooling Fins made of ceramics: Heat transfer properties similar to alumina. Forced convection recommended due to 2 mm spacing between fins. Height 35 mm.
CCS	Ceramic Cooling Surface: Top side of switching module made of ceramics. Heat transfer properties similar to alumina. Max. 20 kVDC isolation. Forced convection recommended.
CCF	Ceramic Cooling Flange: Bottom side of switching module made of a plano grinded ceramic plate. Integrated metal frame for uniform and safe contact pressure. Max. 40 kVDC isolation.
C-DR	Cooling for Driver: Extra cooling for the driver and control electronics. Recommended in combination with option HFS at higher switching frequencies. (2)
GCF	Grounded Cooling Flange: Nickel-plated copper flange for High Power applications. Max. isolation voltage 40kV. Increased coupling capacitance Cc.
GCF-X2	Grounded Cooling Flange, Max. Continuous Power Dissipation increased by x2: Thermal resistance "Switch to Flange" reduced for twice the power capability. (2)
ILC	Indirect Liquid Cooling: Liquid cooling for all kind of conductive coolants including mains water. Internal heat exchanger made of ceramics. For medium power applications.
DLC	Direct Liquid Cooling: Internal cooling channels around the power semiconductors. The most efficient cooling solution especially for high frequency applications. For non-conductive coolants only.
HI-REL	High Reliability / MIL Versions: Available on request. (2)

(1) New option code: Data sheets may differ from this coding system (especially older ones) and do not indicate all possible options as per above table. (2) Please consult factory for detailed information.
(3) These options are EMC-relevant and are recommended for industrial power applications, difficult noise ambients, prototype experiments with flying leads and for users without special EMC design experience.

Further information, data sheets and drawings are available on request. All data and specifications subject to change without notice.

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BEHLKE Product Lines

MAIN

